PCN Number:	20161207002		PCN Date:		e:	Jan. 26, 2017
Title: Datasheet for	SN74AHC1G09					
Customer Contact:	PCN Manager			Dept:		Quality Services
Change Type:						,
Assembly Site		Design			Wafer	Bump Site
Assembly Process		Data Sheet		Ħ		Bump Material
Assembly Materials		Part number change		Ħ		Bump Process
Mechanical Specific		Test Site		一		Fab Site
Packing/Shipping/		Test Process		Ħ		Fab Materials
				Ħ		Fab Process
	Not	ification Details			110101	
Description of Change:						
Texas Instruments Incorp	orated is annour	ncing an information	only n	otifi	cation.	
The product datasheet(s) The following change history Texas INSTRUMENTS		ther details.		MAY 20		SN74AHC1G09 ED SEPTEMBER 2016
						
Changes from Revision C (Janu	ary 2016) to Revision	ı D				Page
Deleted 200-V Machine Mode	I from Features					1
 Changed description for pin A 	from No connection to	Input				3
Added Receiving Notification (of Documentation Upda	ates section				10
The datasheet number wil	l be changing.					
Device Family	С	hange From:				nange To:
	С	Change From:				nange To: CLS724D
Device Family SN74AHC1G09 These changes may be reinttp://www.ti.com/produce	C S viewed at the da	CLS724C atasheet links provide	ed.			
Device Family SN74AHC1G09 These changes may be re	C S viewed at the da	CLS724C atasheet links provide	ed.			
Device Family SN74AHC1G09 These changes may be reshttp://www.ti.com/product Reason for Change: To more accurately reflect	viewed at the da	CLS724C etasheet links provide 9 eristics.			S	CLS724D
Device Family SN74AHC1G09 These changes may be reshttp://www.ti.com/product Reason for Change:	viewed at the da	CLS724C etasheet links provide 9 eristics.		ty (ı	S	CLS724D
Device Family SN74AHC1G09 These changes may be resented to the second for Change: To more accurately reflected.	viewed at the datt/SN74AHC1G0	ccLS724C atasheet links provide eristics. ation, Quality or Rel	iabili		positiv	cLS724D ve / negative):
Device Family SN74AHC1G09 These changes may be reshttp://www.ti.com/product Reason for Change: To more accurately reflect Anticipated impact on I No anticipated impact. Th	viewed at the datt/SN74AHC1G06 device characterit, Form, Function is a specification	eristics. Standard Inks provide Pristics. Stion, Quality or Rel Ston change announce	iabili ment		positiv	cLS724D ve / negative):
Device Family SN74AHC1G09 These changes may be rehttp://www.ti.com/produce Reason for Change: To more accurately reflect Anticipated impact on I No anticipated impact. The actual device.	viewed at the datt/SN74AHC1G06 device characterit, Form, Function is a specification	eristics. Standard Inks provide Pristics. Stion, Quality or Rel Ston change announce	iabili ment		positiv	cLS724D ve / negative):
Device Family SN74AHC1G09 These changes may be resented in the second for Change: To more accurately reflect in the actual device. Changes to product ide	viewed at the datt/SN74AHC1G06 device characterit, Form, Function is a specification	eristics. Standard Inks provide Pristics. Stion, Quality or Rel Ston change announce	iabili ment		positiv	cLS724D ve / negative):

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

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